

# **DAU Student Research Excellence Award**

## **Objective:**

To recognize and celebrate the achievement of the student-led original research that has resulted in publication at a reputed journal or a leading conference.

#### Award:

Award comprises a certificate and plaque/medal. The award is presented by the Director General annually (the day before the convocation ceremony each year) to the students who have published in high quality journals/conferences.

## **Eligibility Criteria:**

All Undergraduate (UG), Postgraduate (PG), and PhD scholars of DAU – either currently enrolled or graduated within one year prior to the upcoming award ceremony – are eligible for this award, provided they have a research paper published in a journal or conference classified under Category I or Category II, as defined below:

Category	Description
I	Q1 journals as per Scimago ranking, or A* or A ranked conferences as per
	either <u>Core.edu</u> or <u>Aminer</u>
II	Q2 journals as per Scimago ranking, or B ranked conferences as per either
	Core.edu or Aminer, or in one of the DAU Approved conferences

#### Notes:

- Refer to Appendix A for a list of DAU Approved conferences.
- The primary affiliation of the student as listed the published paper is required to be DA-IICT or DAU.
- To be eligible for an award during the Pre-Convocation Day ceremony held in year Y, the publication date (as per the DOI) must be between January 1 and December 31 of the calendar year Y–1.
- When a paper is published and its DOI is listed, the student can apply for this award by filling this <u>Google Form</u>. The last date for submitting this form is the 3<sup>rd</sup> January of Year Y for the application to be considered for the award at the pre-convocation day

ceremony to be held in the Year Y. However, students are encouraged to fill in the form as and when their paper is published.

- A student with one or more eligible publications will receive a single award, with an additional certificate provided for each individual paper beyond the first.
- The students who are selected to receive this award will be informed via email latest by 5<sup>th</sup> January of year *Y*. However, students who apply in advance will be informed within a few days of submitting their application. The list of the awardees will be uploaded on the DAU website. The students who cannot attend the award ceremony may contact the Research Officer for collecting the award at a later date.

28<sup>th</sup> May 2025

Handyspodhysy Director General

T. Bandyopadhyay Director General DAU, Gandhinagar

#### **Annexure A: DAU Approved Conferences**

**ICC**: IEEE International Conference on Communications

**ISCAS**: IEEE International Symposium on Circuits and Systems **SPCOM**: Signal Processing and Communications Conference

**NCC**: National Communications Conference

**COMSNETS**: International Conference on COMmunication Systems & NETworkS

ANTS: IEEE International Conference on Advanced Networks and Telecommunications

Systems

HiPC: IEEE International Conference on High Performance Computing

INDOCRYPT: International Conference on Cryptology in India

**ISEC**: Innovations in Software Engineering

ITSC: International Conf on Intelligent Transportation Systems

ICVGIP: Indian Conference on Vision Graphics and Image Processing

**ICDCN**: International Conference on Distributed Computing and Networking

PReMI: International Conference on Pattern Recognition and Machine Intelligence

**CVIP**: International Conference on Computer Vision & Image Processing

ICISS: International Conference on Information Systems Security

FSEN: International Conference on Fundamentals of Software Engineering

TASE: Theoretical Aspects of Software Engineering

CoDS-COMAD: International Conference on Data Science

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**ACC**: American Control Conference

CDC: Conference on Decision and Control

**VLSID**: International Conference on VLSI Design

**EPTC**: Electronics Packaging Technology Conference

**ECTC**: Electronic Components and Technology

**IEEE** NANO: IEEE NANO

**IEEE** SAS: IEEE SAS

**EDAPS**: Electrical Design of Advanced Packaging and Systems

**TENSYMP**: IEEE Region 10 Symposium

**IEEE SENSORS**